MARKING DIAGRAMS

# Low-Voltage CMOS Quad 2-Input AND Gate

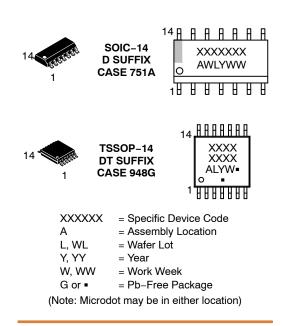
# With 5 V-Tolerant Inputs

# MC74LCX08

The MC74LCX08 is a high performance, quad 2–input AND gate operating from a 1.65 to 5.5 V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. A V<sub>I</sub> specification of 5.5 V allows MC74LCX08 inputs to be safely driven from 5.0 V devices.

#### Features

- Designed for 1.65 V to 5.5 V  $V_{CC}$  Operation
- 5.0 V Tolerant Inputs Interface Capability With 5.0 V TTL Logic
- LVTTL Compatible
- LVCMOS Compatible
- 24 mA Balanced Output Sink and Source Capability @ 3.0 V
- Near Zero Static Supply Current (10 µA) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 100 mA
- ESD Performance: Human Body Model >2000 V
- –Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



### ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

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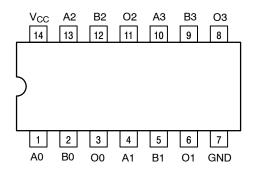


Figure 1. Pinout: 14-Lead (Top View)

#### **PIN NAMES**

Pins Function			
An, Bn	Data Inputs		
On	Outputs		

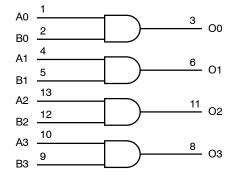


Figure 2. Logic Diagram

### TRUTH TABLE

Inp	Outputs	
An Bn		On
L	L	L
L	н	L
Н	L	L
Н	Н	Н

H = High Voltage Level

L = Low Voltage Level

For  $I_{\mbox{\scriptsize CC}}$  reasons, DO NOT FLOAT Inputs

#### **MAXIMUM RATINGS**

Symbol	Para	Value	Unit	
V <sub>CC</sub>	DC Supply Voltage		–0.5 to +6.5	V
VI	DC Input Voltage (Note 1)		–0.5 to +6.5	V
V <sub>O</sub>	DC Output Voltage (Note 1)	Active–Mode (High or Low State) Tri–State Mode Power–Down Mode (V <sub>CC</sub> = 0 V)	-0.5 to V <sub>CC</sub> + 0.5 -0.5 to +6.5 -0.5 to +6.5	V
I <sub>IK</sub>	DC Input Diode Current	V <sub>I</sub> < GND	-50	mA
Ι <sub>ΟΚ</sub>	DC Output Diode Current	V <sub>O</sub> < GND	-50	mA
Ι <sub>Ο</sub>	DC Output Source/Sink Current		±50	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC Supply Current per Supply Pin or Gr	ound Pin	±100	mA
T <sub>STG</sub>	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for	10 secs	260	°C
ТJ	Junction Temperature Under Bias		+150	°C
$\theta_{JA}$	Thermal Resistance (Note 1)	SOIC-14 QFN14 TSSOP-14	116 130 150	°C/W
P <sub>D</sub>	Power Dissipation in Still Air at 25°C	SOIC-14 QFN14 TSSOP-14	1077 962 833	mW
MSL	Moisture Sensitivity		Level 1	-
F <sub>R</sub>	Flammability Rating Oxygen Index: 28 to	9 34	UL 94 V-0 @ 0.125 in	-
$V_{\text{ESD}}$	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	2000 N/A	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. I<sub>O</sub> absolute maximum rating must be observed.

 Measured with minimum pad spacing on an FR4 board, using 76 mm-by-114 mm, 2-ounce copper trace no air flow per JESD51-7.
 HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol		Parameter	Min	Тур	Max	Unit
V <sub>CC</sub>	Supply Voltage	Operating Data Retention Only	1.65 1.5	3.3 3.3	5.5 5.5	V
VI	Digital Input Voltage		0	_	5.5	V
Vo	Output Voltage	Active Mode (High or Low State) Tri–State Mode Power Down Mode (V <sub>CC</sub> = 0 V)	0 0 0		V <sub>CC</sub> 5.5 5.5	V
T <sub>A</sub>	Operating Free-Air Temperature		-40	-	+125	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise or Fall Rate	$\label{eq:VCC} \begin{array}{l} V_{CC} = 1.65 \; V \; to \; 1.95 \; V \\ V_{CC} = 2.3 \; V \; to \; 2.7 \; V \\ V_{I} \; from \; 0.8 \; V \; to \; 2.0 \; V, \; V_{CC} = 3.0 \; V \\ V_{CC} = 4.5 \; V \; to \; 5.5 \; V \end{array}$	0 0 0 0	- - -	20 20 10 5	nS/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V<sub>CC</sub>). Unused outputs must be left open.

#### DC ELECTRICAL CHARACTERISTICS

				T <sub>A</sub> = -40°C	C to +85°C	T <sub>A</sub> = -40°C	to +125°C	1
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min	Мах	Min	Max	Uni
V <sub>IH</sub> HI	HIGH Level Input Voltage		1.65 — 1.95	0.65 x V <sub>CC</sub>	_	0.65 x V <sub>CC</sub>	_	V
			2.3 – 2.7	1.7	-	1.7	-	
			3.0 - 3.6	2.0	-	2.0	-	
			4.5 – 5.5	0.70 x V <sub>CC</sub>	-	0.70 x V <sub>CC</sub>	-	
V <sub>IL</sub>	LOW Level Input Voltage		1.65 — 1.95	-	0.35 x V <sub>CC</sub>	-	0.35 x V <sub>CC</sub>	V
			2.3 – 2.7	-	0.7	-	0.7	
			3.0 – 3.6	-	0.8	-	0.8	-
			4.5 – 5.5	-	0.30 x V <sub>CC</sub>	-	0.30 x V <sub>CC</sub>	
V <sub>OH</sub>	High-Level Output Voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$ $I_{OH} = -100 \ \mu\text{A}$ $I_{OH} = -4 \ \text{mA}$ $I_{OH} = -8 \ \text{mA}$ $I_{OH} = -12 \ \text{mA}$	1.65 to 5.5 1.65 2.3 2.7	V <sub>CC</sub> - 0.1 1.29 1.8 2.2	- - -	V <sub>CC</sub> - 0.1 1.29 1.8 2.2	- - -	V
		$I_{OH} = -12 \text{ mA}$ $I_{OH} = -16 \text{ mA}$ $I_{OH} = -24 \text{ mA}$ $I_{OH} = -32 \text{ mA}$	3.0 3.0 4.5	2.4 2.2 3.7	-	2.4 2.2 3.7	- -	
VoL	Low-Level Output Voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$ $I_{OL} = 100 \ \mu\text{A}$ $I_{OL} = 4 \ \text{mA}$ $I_{OL} = 8 \ \text{mA}$ $I_{OL} = 12 \ \text{mA}$ $I_{OL} = 16 \ \text{mA}$ $I_{OL} = 24 \ \text{mA}$ $I_{OL} = 32 \ \text{mA}$	1.65 to 5.5 1.65 2.3 2.7 3.0 3.0 4.5	- - - - - -	0.1 0.24 0.3 0.4 0.4 0.55 0.6	- - - - - -	0.1 0.24 0.3 0.4 0.4 0.55 0.6	V
I <sub>I</sub>	Input Leakage Current	V <sub>I</sub> = 0 to 5.5 V	3.6	-	±5.0	-	±5.0	μA
I <sub>OFF</sub>	Power Off Leakage Current	V <sub>I</sub> = 5.5 V or V <sub>O</sub> = 5.5 V	0	-	10	-	10	μA
I <sub>CC</sub>	Quiescent Supply Current	$V_{I}$ = 5.5 V or GND	3.6	-	10	-	10	μA
$\Delta I_{CC}$	Increase in I <sub>CC</sub> per Input	$V_{IH} = V_{CC} - 0.6 V$	2.3 to 3.6	-	500	_	500	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### AC ELECTRICAL CHARACTERISTICS

				T <sub>A</sub> = −40°C to +85°C		$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$		
Symbol	Parameter	Test Condition	V <sub>CC</sub> (V)	Min	Max	Min	Мах	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay, Input to Output	See Figures 3 and 4	1.65 to 1.95	-	9.8	-	9.8	ns
			2.3 to 2.7	-	6.6	-	6.6	
			2.7	-	6.2	-	6.2	
			3.0 to 3.6	-	5.5	-	5.5	
			4.5 to 5.5	-	4.0	_	4.0	

#### AC ELECTRICAL CHARACTERISTICS

				T <sub>A</sub> = -40°C to +85°C		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C \qquad T_A = -40^{\circ}C \text{ to } +125^{\circ}C$		to +125°C	
Symbol	Parameter	Test Condition	V <sub>CC</sub> (V)	Min	Max	Min	Мах	Unit	
t <sub>OSHL</sub> , Output to Output Skew t <sub>OSLH</sub>		1.65 to 1.95	-	-	-	-	ns		
			2.3 to 2.7	-	-	-	-		
			2.7	-	-	-	-		
			3.0 to 3.6	-	1.0	-	1.0		
			4.5 to 5.5	-	-	-	-		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

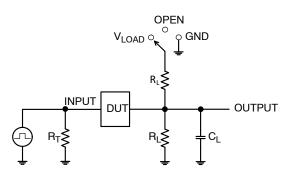
#### DYNAMIC SWITCHING CHARACTERISTICS

			T <sub>A</sub> = +25°C			
Symbol	Characteristic	Condition	Min	Тур	Max	Unit
V <sub>OLP</sub>	Dynamic LOW Peak Voltage	$V_{CC}$ = 3.3 V, $C_L$ = 50 pF, $V_{IH}$ = 3.3 V, $V_{IL}$ = 0 V		0.8		V
	(Note 5)	$V_{CC}$ = 2.5 V, $C_L$ = 30 pF, $V_{IH}$ = 2.5 V, $V_{IL}$ = 0 V		0.6		V
V <sub>OLV</sub>	Dynamic LOW Valley Voltage	$V_{CC}$ = 3.3 V, $C_L$ = 50 pF, $V_{IH}$ = 3.3 V, $V_{IL}$ = 0 V		-0.8		V
	(Note 5)	$V_{CC}$ = 2.5 V, $C_L$ = 30 pF, $V_{IH}$ = 2.5 V, $V_{IL}$ = 0 V		-0.6		V

5. Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.

#### **CAPACITIVE CHARACTERISTICS**

Symbol	Parameter	Condition	Typical	Unit
C <sub>IN</sub>	Input Capacitance	$V_{CC}$ = 3.3 V, $V_{I}$ = 0 V or $V_{CC}$	7	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC}$ = 3.3 V, $V_{I}$ = 0 V or $V_{CC}$	8	pF
C <sub>PD</sub>	Power Dissipation Capacitance	10 MHz, $V_{CC}$ = 3.3 V, $V_{I}$ = 0 V or $V_{CC}$	25	pF



V....

Test	Switch Position
t <sub>PLH</sub> / t <sub>PHL</sub>	Open
t <sub>PLZ</sub> / t <sub>PZL</sub>	V <sub>LOAD</sub>
t <sub>PHZ</sub> / t <sub>PZH</sub>	GND

 $C_L$  includes probe and jig capacitance  $R_T$  is  $Z_{OUT}$  of pulse generator (typically 50  $\Omega)$  f = 1 MHz

10%

tрн

 $t_{\text{PLH}}$ 

t<sub>r</sub> = 2.5 ns

INPUT

OUTPUT

OUTPUT

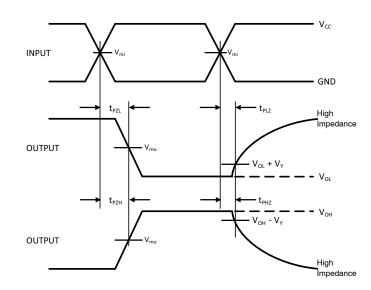


Figure	3.	Test	Circuit

t<sub>f</sub> = 2.5 ns

10%

۷.

V<sub>ma</sub>

t<sub>PLH</sub>

 $t_{\text{PHL}}$ Þ

Vcc

GND

V<sub>OH</sub>

Vo

V<sub>OH</sub>

 $V_{\text{OL}}$ 

V <sub>CC</sub> , V	$R_{L}, \Omega$	C <sub>L</sub> , pF	V <sub>LOAD</sub>	V <sub>m</sub> , V	V <sub>Y</sub> , V
1.65 to 1.95	500	30	$2 \times V_{CC}$	V <sub>CC</sub> /2	0.15
2.3 to 2.7	500	30	$2 \times V_{CC}$	V <sub>CC</sub> /2	0.15
2.7	500	50	6 V	1.5	0.3
3.0 to 3.6	500	50	6 V	1.5	0.3
4.5 to 5.5	500	50	$2 \times V_{CC}$	V <sub>CC</sub> /2	0.3

Figure 4. Switching Waveforms

#### **ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
MC74LCX08DG	LCX08G	SOIC-14	55 Units / Rail
MC74LCX08DR2G	LCX08G	SOIC-14	2500 / Tape & Reel
MC74LCX08DTG	LCX 08	TSSOP-14	96 Units / Rail
MC74LCX08DTR2G	LCX 08	TSSOP-14	2500 / Tape & Reel
MC74LCX08DTR2G-Q*	LCX 08	TSSOP-14	2500 / Tape & Reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
 \*-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

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#### **STYLES ON PAGE 2**

 
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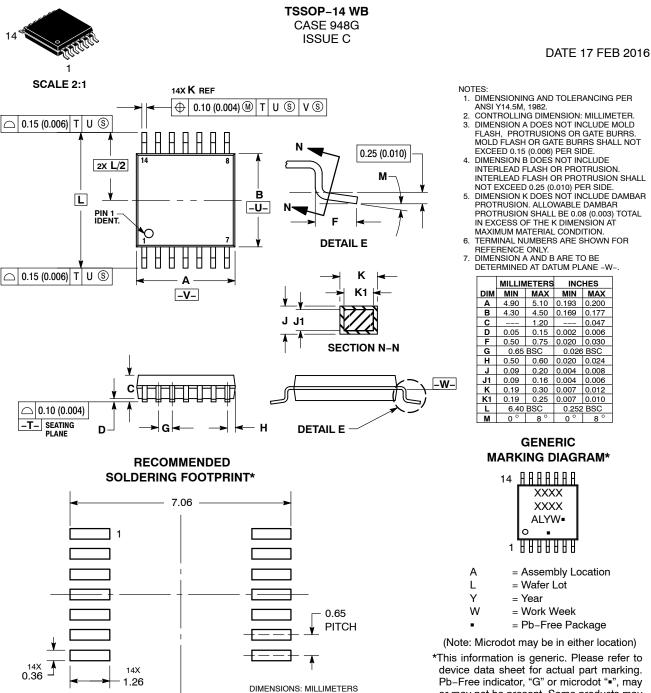
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STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 8. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. ANODE/CATHODE 7. ANODE/CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON CATHODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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